Docket No.

240627US0

IN RE APPLICATION OF: Yoshifumi INOUE

SERIAL NO: 10/625,512

FILED:

July 24, 2003

FOR:

FLAME RETARDANT EPOXY RESIN COMPOSITION, SEMICONDUCTOR ENCAPSULATING MATERIAL

USING SAME, AND RESIN ENCAPSULATED SEMICONDUCTOR DEVICE

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

Transmitted herewith is an amendment in the above-identified application.

- No additional fee is required
- ☐ Small entity status of this application under 37 C.F.R. §1.9 and §1.27 is claimed.
- ☐ Additional documents filed herewith:

The Fee has been calculated as shown below:

| CLAIMS | CLAIMS REMAINING | | HIGHEST NUMBER PREVIOUSLY PAID | NO. EXTRA CLAIMS | | RATE | , | CALCULATIONS |
|-------------|---------------------|-----------------------------|---|------------------------|-----|--------|-----|--------------|
| TOTAL | 19 | MINUS | 20 | 0 | x | \$50 | = | \$0.00 |
| INDEPENDENT | 2 | MINUS | 3 | 0 | х | \$200 | = | \$0.00 |
| | | ☐ MULTIPL | E DEPENDENT | CLAIMS | + | \$360 | = | \$0.00 |
| | | | TOTAL | OF ABOVE CA | LCI | JLATIC | ONS | \$0.00 |
| | | ☐ Reduction | by 50% for filing | by Small Entity | | | | \$0.00 |
| | | ☐ Recordation of Assignment | | | + | \$40 | = | \$0.00 |
| | | | | | | TOT | AL | \$0.00 |

| | A check | in the | amount | of | \$0.00 | is | attached | |
|--|---------|--------|--------|----|--------|----|----------|--|
|--|---------|--------|--------|----|--------|----|----------|--|

- Credit card payment form is attached to cover the fees in the amount of \$0.00
- Please charge any additional Fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.
- If these papers are not considered timely filed by the Patent and Trademark Office, then a petition is hereby made under 37 C.F.R. §1.136, and any additional fees required under 37 C.F.R. §1.136 for any necessary extension of time may be charged to Deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.

Norman F. Oblon

Frederick D. Vastine, Ph.D.

Registration No. 27,013

Customer Number

22850

Tel. (703) 413-3000 Fax. (703) 413-2220 (OSMMN 05/03)

Application No. 10/625,512

Reply to Office Action of April 20, 20056 PE

DOCKET NO: 240627US0

& TRADEMARK OFFICE IN THE UNITED STATES P

IN RE APPLICATION OF

YOSHIFUMI INOUE : EXAMINER: ROBERTSON, J.

SERIAL NO: 10/625,512

FILED: JULY 24, 2003 : GROUP ART UNIT: 1712

FOR: FLAME RETARDANT EPOXY RESIN COMPOSITION, SEMICONDUCTOR ENCAPSULATING MATERIAL USING SAME, AND RESIN **ENCAPSULATED SEMICONDUCTOR**

DEVICE

AMENDMENT

COMMISSIONER FOR PATENTS P. O. BOX 1450 ALEXANDRIA, VIRGINIA 22313-1450

SIR:

Responsive to the Office Action dated April 20, 2005, please amend the aboveidentified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.